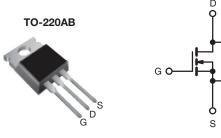
Vishay Siliconix



Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	60				
R _{DS(on)} (Ω)	V _{GS} = 10 V 0.028				
Q _g (Max.) (nC)	67				
Q _{gs} (nC)	18				
Q _{gd} (nC)	25				
Configuration	Single				



N-Channel MOSFET

FEATURES

- Advanced Process Technology
- Ultra Low On-Resistance
- Dynamic dV/dt Rating
- 175 °C Operating Temperature
- Fast Switching
- Fully Avalanche Rated
- Drop in Replacement of the IRFZ44, SiHFZ44 for Linear/Audio Applications
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Advanced Power MOSFETs from Vishay utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that Power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in a wide variety of applications.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRFZ44RPbF			
	SiHFZ44R-E3			
SnPb	IRFZ44R			
	SiHFZ44R			

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \text{ °C}$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	60	V	
Gate-Source Voltage			V _{GS}	± 20	v	
Continuous Drain Current ^e	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I _D	50		
Continuous Drain Current	VGS at 10 V	T _C = 100 °C		36	А	
Pulsed Drain Current ^a			I _{DM}	200		
Linear Derating Factor				1.0	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	100	mJ	
Maximum Power Dissipation	T _C =	25 °C	PD	150	W	
Peak Diode Recovery dV/dt ^c			dV/dt	4.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 175	°C	
Soldering Recommendations (Peak Temperature) ^d	for 10 s			300		
Manualia a Tanana	6-32 or M3 screw			10	lbf ∙ in	
Mounting Torque			-	1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = 25 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 44 µH, $R_g = 25 \Omega$, $I_{AS} = 51 \text{ A}$ (see fig. 12). c. $I_{SD} \leq 51 \text{ A}$, $dV/dt \leq 250 \text{ A/µs}$, $V_{DD} \leq V_{DS}$, $T_J \leq 175 \text{ °C}$.

d. 1.6 mm from case.

e. Current limited by the package, (die current = 51 A).

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-		62 - 1.0				
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50				°C/W		
Maximum Junction-to-Case (Drain)	R _{thJC}	-						
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, u	nless otherw	ise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0$	V, I _D = 2	50 µA	60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to	o 25 °C,	I _D = 1 mA	-	0.060	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{C}$	_{GS} , I _D = 2	50 μA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	Vo	_{GS} = ± 20		-	-	± 100	nA
		V _{DS} = 6	0 V, V _{GS}	= 0 V	-	-	25	
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 48 V, V _{GS} = 0 V, T _J = 150 °C		-	-	250	μA	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		l _D = 31 A ^b	-	-	0.028	Ω
Forward Transconductance	9 _{fs}	V _{DS} = 2	5 V, I _D =	31 A ^b	15	-	-	S
Dynamic								
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	1900	-	pF	
Output Capacitance	C _{oss}			-	920	-		
Reverse Transfer Capacitance	C _{rss}			-	170	-		
Total Gate Charge	Qg			-	-	67		
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 V$ $I_D = 51 A, V_{DS} = 48 V,$		-	-	18	nC
Gate-Drain Charge	Q _{gd}	$V_{GS} = 10^{\circ}$ see fig. 6 and 13°		-	-	25	1	
Turn-On Delay Time	t _{d(on)}	V_{DD} = 30 V, I _D = 51 A, R _g = 9.1 Ω, R _D = 0.55 Ω, see fig. 10 ^b		-	14	-	- ns	
Rise Time	t _r			-	110	-		
Turn-Off Delay Time	t _{d(off)}			-	45	-		
Fall Time	t _f			-	92	-		
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	الم	
Internal Source Inductance	L _S			-	7.5	-	nH	
Drain-Source Body Diode Characteristic	cs							
Continuous Source-Drain Diode Current	۱ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	50°	А	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	200	~	
Body Diode Voltage	V_{SD}	$T_J = 25 \ ^\circ C, \ I_S = 51 \ A, \ V_{GS} = 0 \ V^b$		-	-	2.5	V	
Body Diode Reverse Recovery Time	t _{rr}	- T _J = 25 °C, I _F = 51 A, dl/dt = 100 A/μs ^b		-	120	180	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.53	0.80	μC	
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn			-on is dor	ninated b	y L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

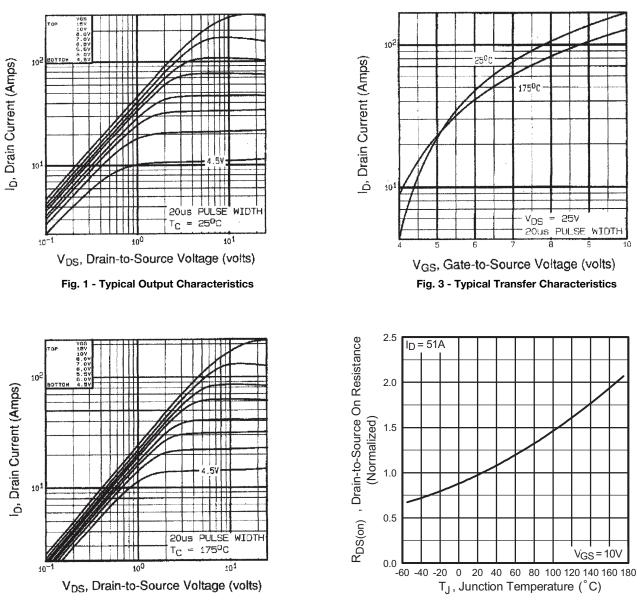
b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

c. Current limited by the package (die current = 51 A).

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 2 - Typical Output Characteristics

Fig. 4 - Normalized On-Resistance vs. Temperature

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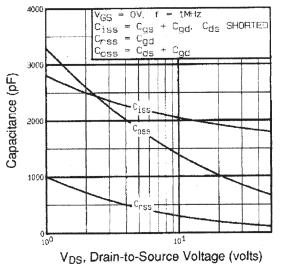


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

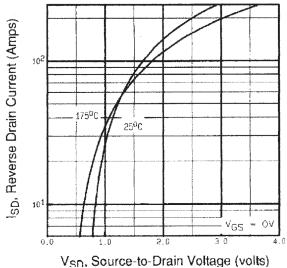


Fig. 7 - Typical Source-Drain Diode Forward Voltage

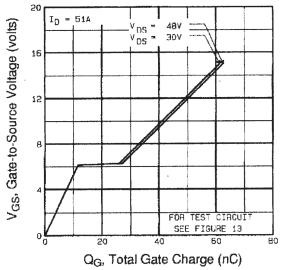
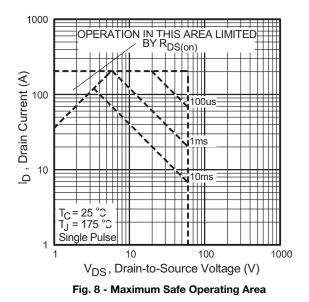


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



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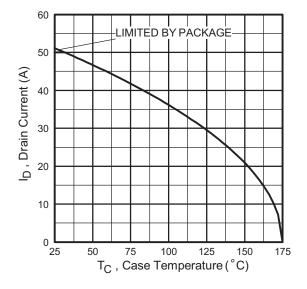


Fig. 9 - Maximum Drain Current vs. Case Temperature

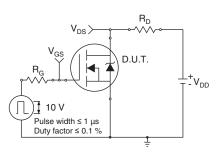


Fig. 10a - Switching Time Test Circuit

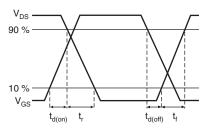


Fig. 10b - Switching Time Waveforms

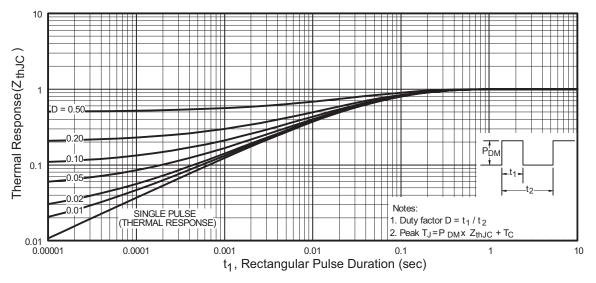


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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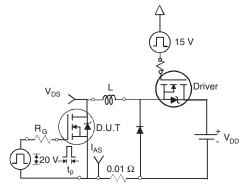


Fig. 12a - Unclamped Inductive Test Circuit

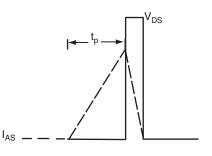


Fig. 12b - Unclamped Inductive Waveforms

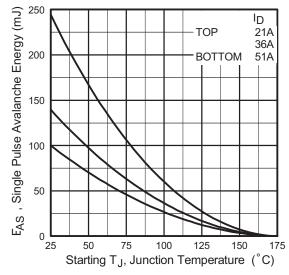


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

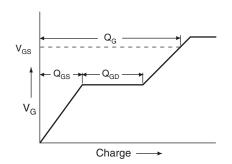


Fig. 13a - Basic Gate Charge Waveform

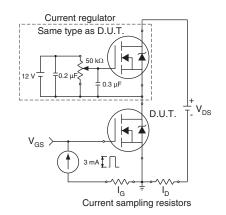


Fig. 13b - Gate Charge Test Circuit

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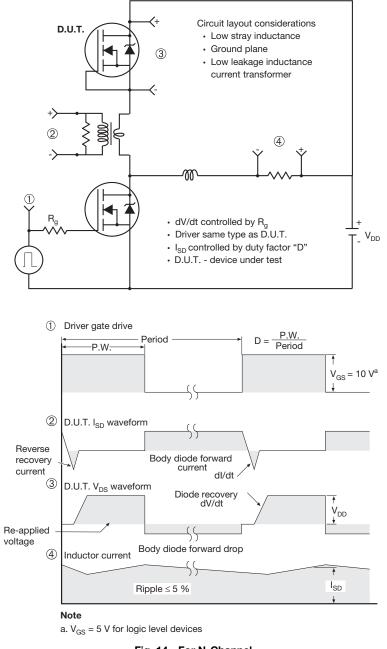


Fig. 14 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture						
ASE		Xi'an				
		IRF 9510 744K AB				

Revison: 14-Dec-15

1 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 66542

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